

Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) @ 10 mA		Description
			Min.	Typ.	
KPSA04-123	GREEN (InGaAlP)	WHITE DIFFUSED	4700	17400	Common Anode, Rt. Hand Decimal.

Electrical / Optical Characteristics at TA=25°C

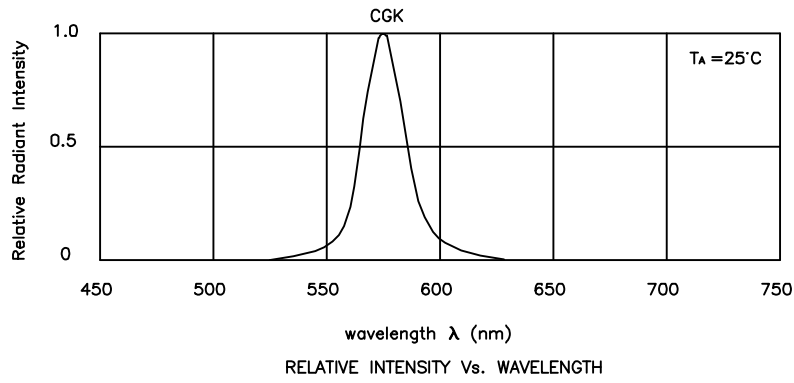
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Green	574		nm	IF=20mA
λ_D	Dominant Wavelength	Green	570		nm	IF=20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Green	20		nm	IF=20mA
C	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF	Forward Voltage	Green	2.1	2.5	V	IF=20mA
IR	Reverse Current	Green		10	uA	VR = 5V

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

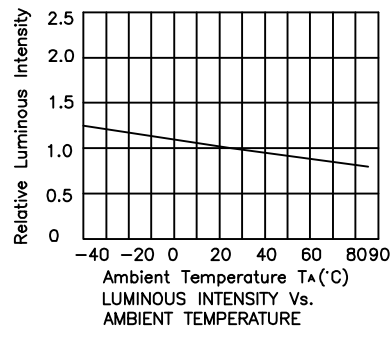
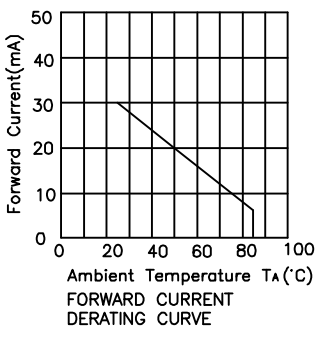
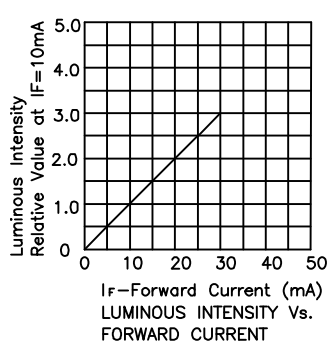
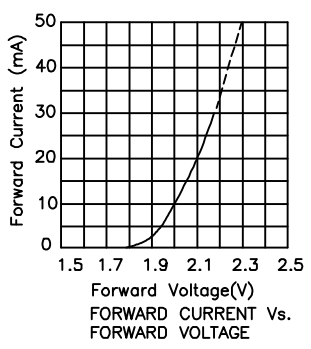
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



Green

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Remarks:

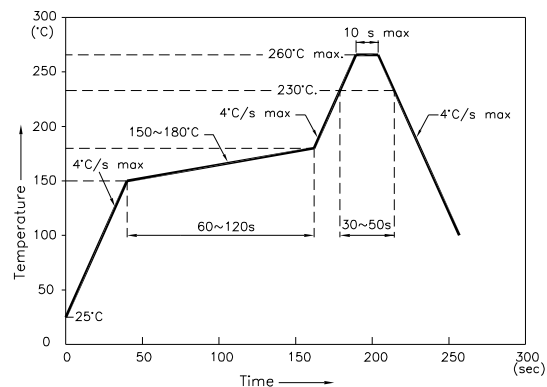
If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity/ Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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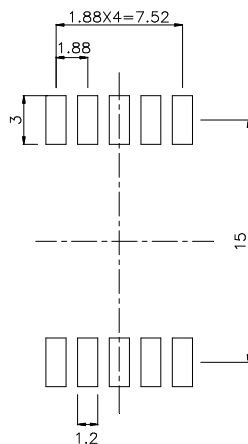
Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. No more than once.

Recommended Soldering Pattern (Units : mm)



Tape Specifications (Units : mm)

